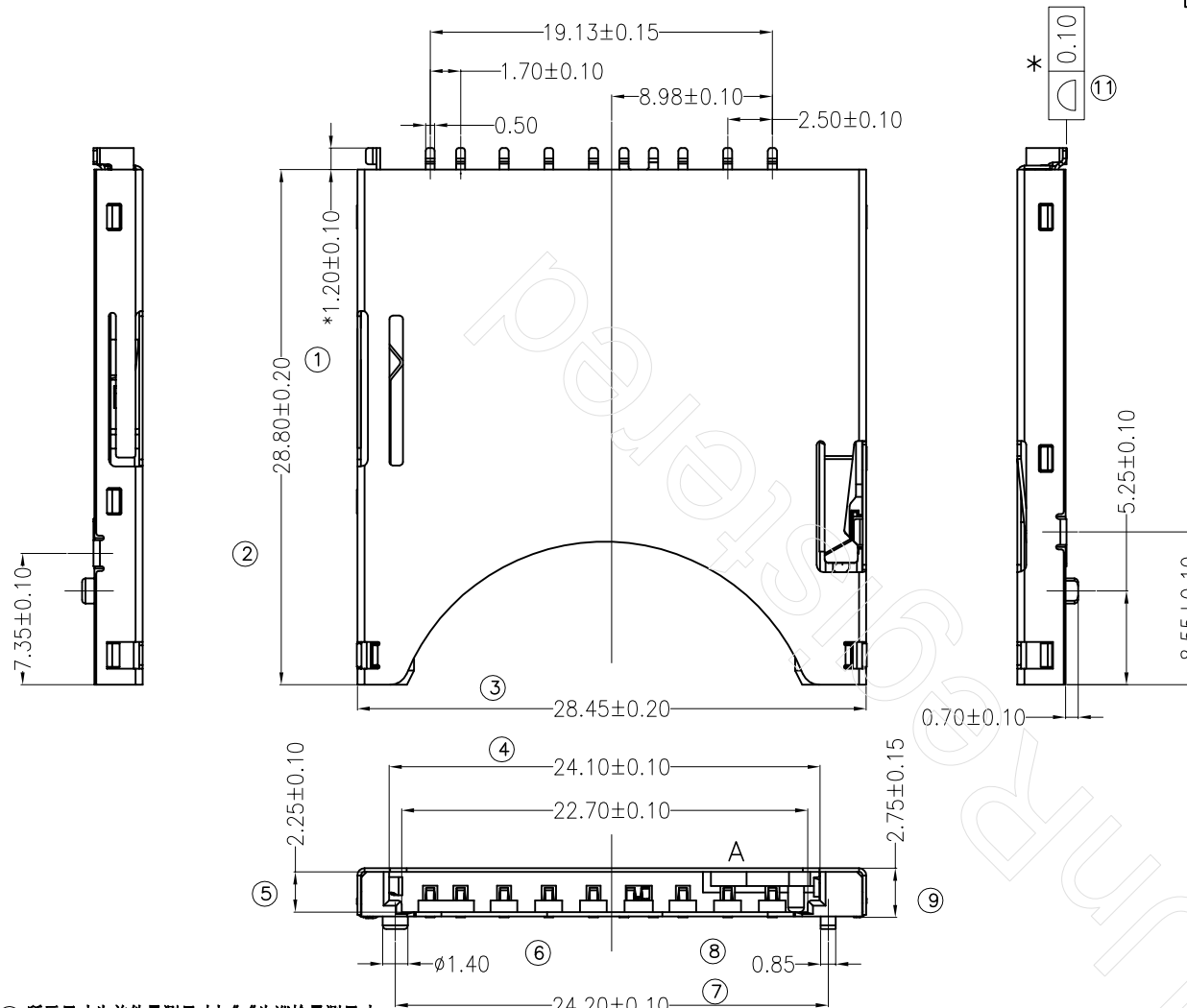
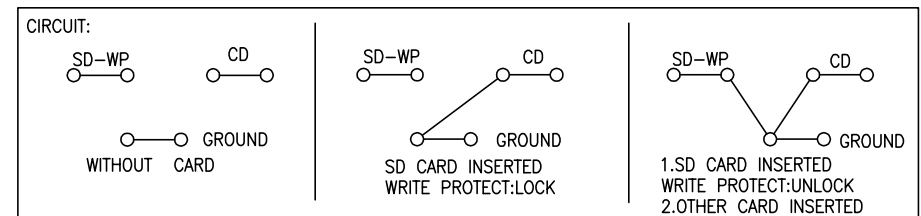


\* 所有原料材质, 生产制程, 电镀必须符合ROHS要求



备注:加 ① 所示尺寸为首件量测尺寸加"\*"为巡检量测尺寸



REVISION NO.	ECR NO.	DESCRIPTION	MARK	DATE
1				
2				
3				

### Specification

**MATERIAL:**  
 Insulator: High Temperature Thermoplastic, UL 94V-0.  
 Contact: Copper Alloy

**PLATING:**  
 Contact: Plated 50u" Ni Overall  
 Plated Au Selective Contact Area  
 Plated 100u" Sn Over Ni On Solder Area  
 Shell: Plated 50u" Ni Overall  
 Plated 1u" Au Over Ni On Solder Area

**Electrical:**  
 Current Rating :0.5mA AC/DC max.  
 Voltage Rating :125V AC/DC  
 Ambient Temperature Range :-20°C~+60°C  
 Storage Temperature Range :-40°C~+70°C  
 Ambient Humidity Range :95% R.H. Max.  
 Contact Resistance:100mΩ max.  
 Insulation Resistance:1000MΩ min./500VDC  
 Mating Cycles:10,000 Insertions

**Usable Memory Card:**  
 SD&MMC Card

Pin No.	SD	MMC
P1	MMC-DAT SD-DAT3	1P
P2	MMC-CMD SD-CMD	2P
P3	MMC-VSS1 SD-VSS1	3P
P4	MMC-VDD SD-VDD	4P
P5	MMC-CLK SD-CLK	5P
P6	MMC-VSS2 SD-VSS2	6P
P7	MMC-DAT SD-DAT0	7P
P8	SD-DAT1	8P
P9	SD-DAT2	9P



深圳市鑫南天科技有限公司  
 Shen zhen Shi Xin Nan Tian Industrial Co.,Lcd

DIMENSIONS INIT: mm  
 UNLESS OTHERWISE SPECIFIABLE

DIMENSION	TOLERANCE
X.X: ±	0.25
X.XX: ±	0.10
X.XXX: ±	0.05
ANGULAR: ±	1°

PRODUCT NAME : SD push-push板上内脚	DRAWING: COCO	DATE: 2008/12/10
PRODUCT NO. : SD-001-001	CHECK: JANY	DATE: 2008/12/10
DRAWING NO. : NT-001	APPROVED: JEFF	DATE: 2008/12/10
SCALE: 1:1	DWG ID: P D	REV.: A
		PAGE: 1 of 3